

STE88N65M5

Datasheet - production data

N-channel 650 V, 0.024 Ω typ., 88 A, MDmesh[™] V Power MOSFET in a ISOTOP[™] package

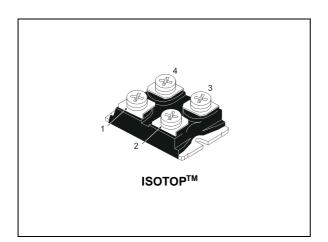
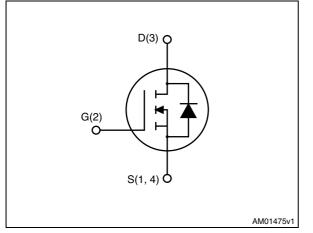


Figure 1. Internal schematic diagram



Features

Order code	V _{DS} @T _{jmax}	R _{DS(on)} max	I _D
STE88N65M5	710 V	0.029 Ω	88 A

- Very low R_{DS(on)}
- Higher V_{DSS} rating
- Higher dv/dt capability
- Excellent switching performance
- 100% avalanche tested

Applications

• Switching applications

Description

This device is an N-channel MDmesh[™] V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH[™] horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

Table 1. Device summary

Order code	Marking	Packages	Packaging
STE88N65M5	88N65M5	ISOTOP	Tube

This is information on a product in full production.

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1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate- source voltage	± 25	V
I _D	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	88	Α
I _D	Drain current (continuous) at T _C = 100 °C	55.7	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	352	Α
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	494	W
I _{AR}	Max current during repetitive or single pulse avalanche (pulse width limited by T_{JMAX})	15	A
E _{AS}	Single pulse avalanche energy (starting $T_j = 25^{\circ}C$, $I_D = I_{AR}$, $V_{DD} = 50V$)	2000	mJ
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
Тj	Max. operating junction temperature	150	°C

Table 2.	Absolute	maximum	ratings
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1. Pulse width limited by safe operating area.

2. $I_{SD} \leq 88$ A, di/dt = 400 A/ μ s, V_{DD} = 400 V, V_{DS (peak)} < V_{(BR)DSS}.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.253	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	30	°C/W



2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	650			V
1	Zero gate voltage	V _{DS} = 650 V			1	μA
IDSS	drain current ($V_{GS} = 0$)	V _{DS} = 650 V, T _C =125 °C			100	μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 42 A		0.024	0.029	Ω

Table 4. On /off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	8825	-	pF
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	223	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0	-	11	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	$V_{GS} = 0, V_{DS} = 0$ to 520 V	-	778	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0, V_{DS} = 0$ to 520 V	-	202	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz open drain	-	1.79	-	Ω
Qg	Total gate charge	V _{DD} = 520 V, I _D = 42 A,	-	204	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	51	-	nC
Q _{gd}	Gate-drain charge	(see Figure 16)	-	84	-	nC

1. $C_{o(tr)}$ is a constant capacitance value that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

C_{o(er)} is a constant capacitance value that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.



Table 6. Switching times								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
t _{d(v)}	Voltage delay time	V _{DD} = 400 V, I _D = 56 A,	-	141	-	ns		
t _{r(v)}	Voltage rise time	$R_{G} = 4.7 \Omega, V_{GS} = 10 V$	-	16	-	ns		
t _{f(i)}	Current fall time	(see Figure 17)	-	29	-	ns		
t _{c(off)}	Crossing time	(see <i>Figure 20</i>)	-	56	-	ns		

Table 6. Switching times

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		88	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		352	А
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 88 A, V _{GS} = 0	-		1.5	V
t _{rr}	Reverse recovery time		-	544		ns
Q _{rr}	Reverse recovery charge	$I_{SD} = 84$ A, di/dt = 100 A/ μ s V _{DD} = 100 V (see <i>Figure 17</i>)	-	14		μC
I _{RRM}	Reverse recovery current		-	50		А
t _{rr}	Reverse recovery time	I _{SD} = 84 A, di/dt = 100 A/µs	-	660		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 100 V, T _j = 150 °C	-	20		μC
I _{RRM}	Reverse recovery current	(see Figure 17)	-	60		А

1. Pulse width limited by safe operating area.

2. Pulsed: pulse duration = $300 \,\mu$ s, duty cycle 1.5%



2.1 Electrical characteristics (curves)

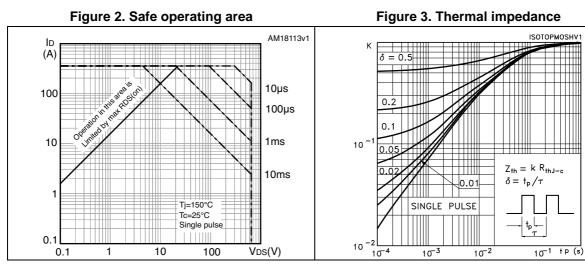
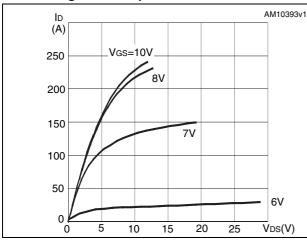
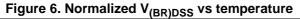


Figure 4. Output characteristics





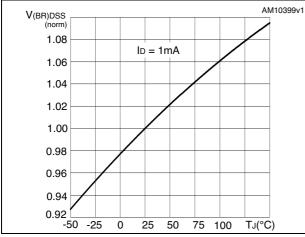
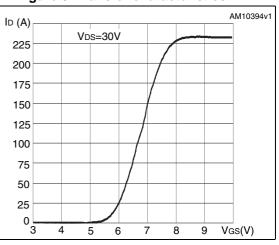
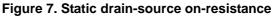
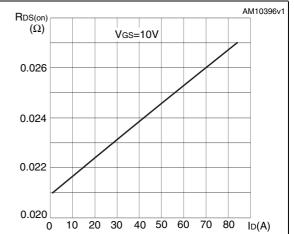


Figure 5. Transfer characteristics









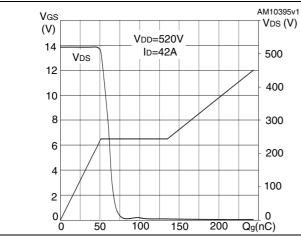
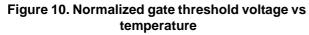


Figure 8. Gate charge vs gate-source voltage



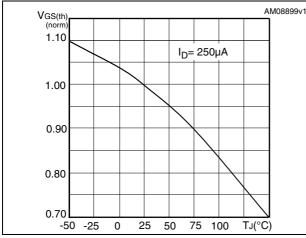
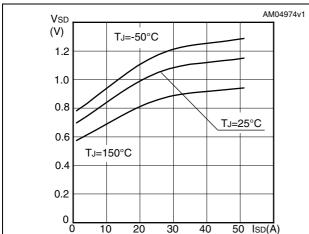


Figure 12. Source-drain diode forward characteristics



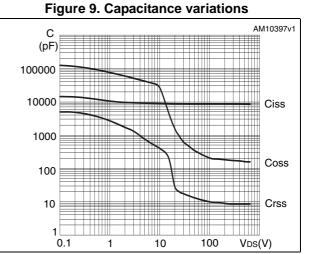


Figure 11. Normalized on-resistance vs temperature

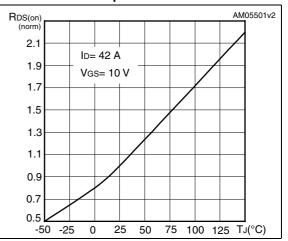
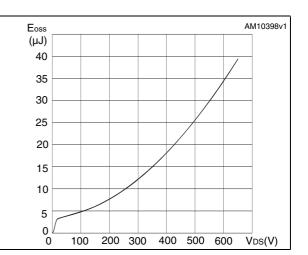


Figure 13. Output capacitance stored energy





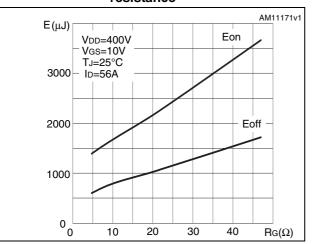


Figure 14. Switching losses vs gate resistance ⁽¹⁾

1. Eon including reverse recovery of a SiC diode.

Test circuits 3

Figure 15. Switching times test circuit for resistive load

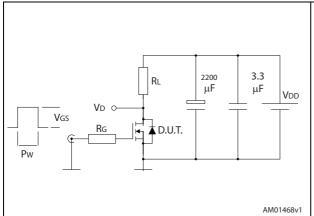


Figure 17. Test circuit for inductive load switching and diode recovery times

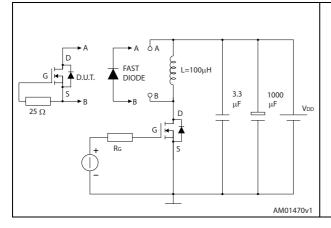
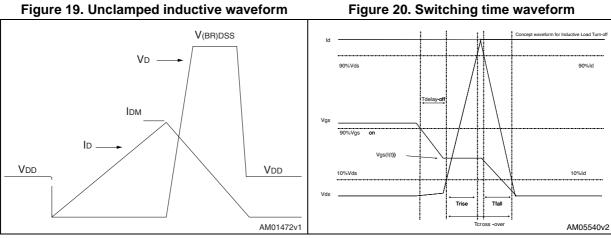
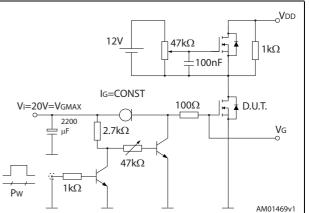
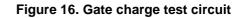


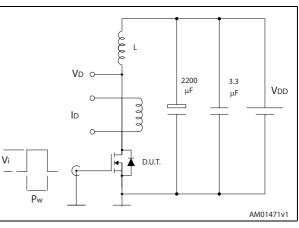
Figure 19. Unclamped inductive waveform













4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



Figure 21. ISOTOP drawing

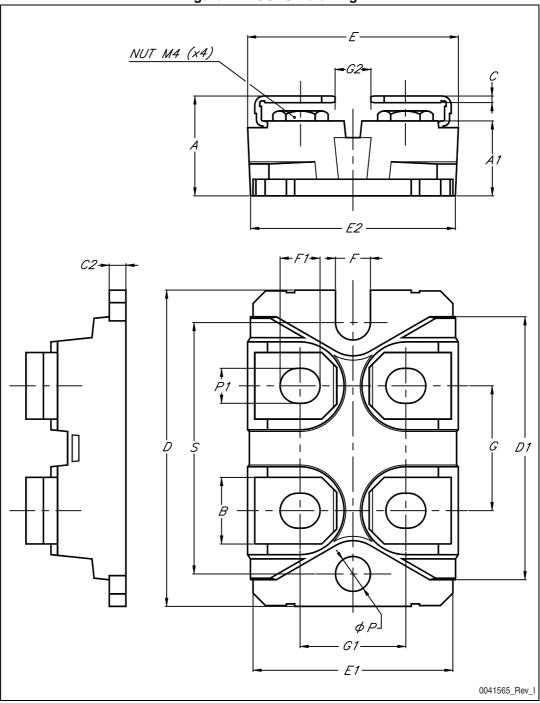




Table 8. ISOTOP mechanical data					
Dim.		mm			
	Min.	Тур.	Max.		
А	11.80		12.20		
A1	8.90		9.10		
В	7.80		8.20		
С	0.75		0.85		
C2	1.95		2.05		
D	37.80		38.20		
D1	31.50		31.70		
E	25.15		25.50		
E1	23.85		24.15		
E2		24.80			
G	14.90		15.10		
G1	12.60		12.80		
G2	3.50		4.30		
F	4.10		4.30		
F1	4.60		5		
φP	4		4.30		
P1	4		4.40		
S	30.10		30.30		

Table 8. ISOTOP mechanical data



5 Revision history

Table 9	. Document	revision	history
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Date	Revision	Changes
24-Feb-2014	1	Initial release.



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